

SBR3U40P1

3.0A SBR<sup>®</sup> SUPER BARRIER RECTIFIER *PowerDI*<sup>®</sup>123

#### Features

- Ultra Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Interlocking Clip Design for High Surge Current
  Capacity
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: PowerDl<sup>®</sup>123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Polarity Indicator: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 🕄
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.018 grams (approximate)



Top View

### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>		
Working Peak Reverse Voltage	V <sub>RWM</sub>	40	V
DC Blocking Voltage	V <sub>RM</sub>		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Rectified Output Current (See Figure 1)	lo	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	75	A

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 2) Thermal Resistance Junction to Ambient (Note 3) Thermal Resistance Junction to Ambient (Note 4)	R <sub>0JS</sub> R <sub>0JA</sub> R <sub>0JA</sub>	5 175 100	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

# **Electrical Characteristics** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V <sub>(BR)R</sub>	40	-	-	V	I <sub>R</sub> = 400μA
Forward Voltage Drop	V <sub>F</sub>	- -	0.30 0.34 0.42	0.34 0.39 0.47	V	$\begin{split} I_F &= 0.5 \text{A}, \ T_J = 25^{\circ}\text{C} \\ I_F &= 1.0 \text{A}, \ T_J = 25^{\circ}\text{C} \\ I_F &= 3.0 \text{A}, \ T_J = 25^{\circ}\text{C} \end{split}$
Leakage Current (Note 5)	I <sub>R</sub>	-	70 8	400 40	μA mA	$V_R = 40V, T_J = 25^{\circ}C$ $V_R = 40V, T_J = 125^{\circ}C$

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see *EU Directive 2002/95/EC Annex Notes*.

2. Theoretical Reus calculated from the top center of the die straight down to the PCB cathode tab solder junction.

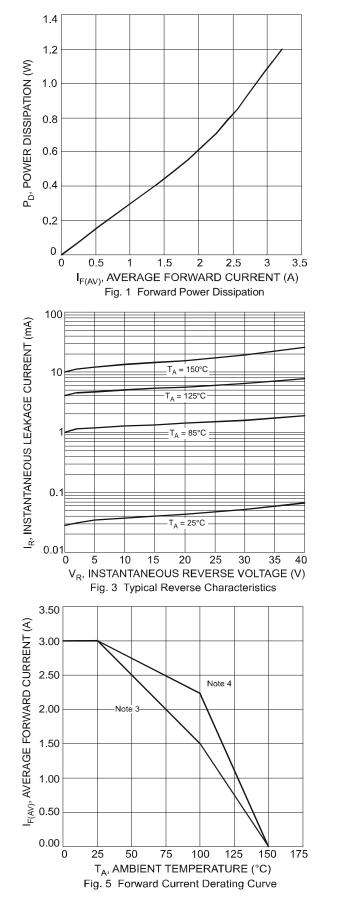
3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.

4. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.

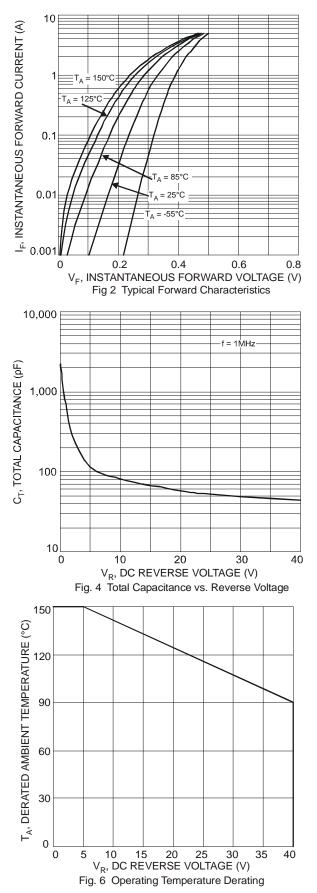
5. Short duration pulse test used to minimize self-heating effect.

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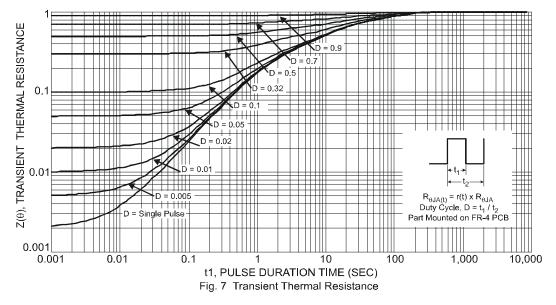


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2 of 4 www.diodes.com



### SBR3U40P1



### Ordering Information (Note 6)

Case	Packaging
PowerDI <sup>®</sup> 123	3000/Tape & Reel
	PowerDI <sup>®</sup> 123

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

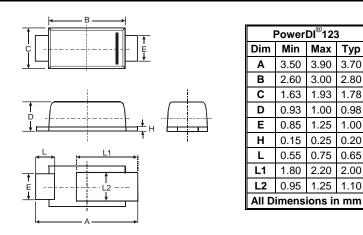
# **Marking Information**

S <u>V</u> 4 ⋛
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SV4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: U = 2007) M = Month (ex: 9 = September)

Date Code Key												
Year	2007	20	08	2009	2010	20	11	2012	2013	20	14	2015
Code	U	١	/	W	Х	Ň	Y	Z	А	I	3	С
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

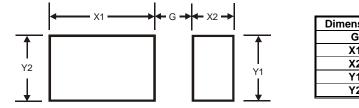
### **Package Outline Dimensions**



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# Suggested Pad Layout



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4

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